AN2514S

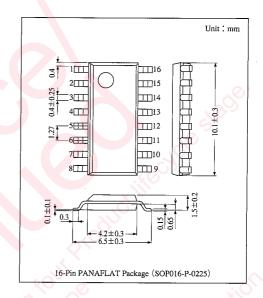
Electronic View-finder Driving IC with Synchronous Signal

Overview

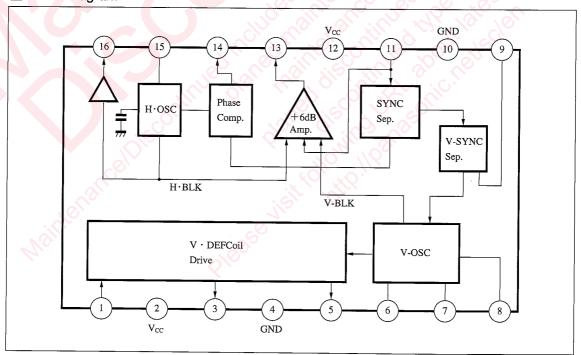
The AN2514S is an integrated circuit designed for driving the monochrome monitor (view finder) of the video camera, and its idling current of the vertical driving circuit is increased from that of the AN2513S, and it is possible to easily make up a 1.5-inch electronic view finder driving circuit by inputting a video signal. VD output is available for timing-reference of character.

Features

- Video amp, synchronous separation circuit, horizontal/vertical oscillation circuit, AFC circuit, and vertical driving circuit built-in
- · A vertical deflection coil can be driven directly.
- · Horizontal oscillating capacitors built-in



■ Block Diagram



■ Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Supply voltage	V _{CC1} /V _{CC2}	5.5	V
Power dissipation (Ta=75℃)	P_D	260 *	mW
Operating ambient temperature	T_{opr}	-20 to +75	$^{\circ}$
Storage temperature	$T_{ m stg}$	-55 to +125	$^{\circ}$

^{*} Value when mounted on the printed circuit board

■ Recommended Operating Range $(Ta=25^{\circ}C)$

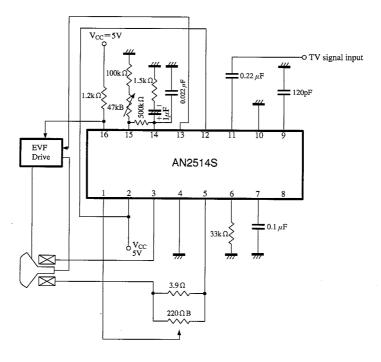
Parameter	Symbol	Range
Operating supply voltage range	V_{CC1}, V_{CC2}	4.5V to 5.3V

\blacksquare Electrical Characteristics $(V_{CC1}=5V, V_{CC2}=5V, Ta=25^{\circ}C)$

Parameter	Symbol	Condition	min	typ	max	Unit
G' '	I _{CC1(2)}	No load	2.35	7.5	13	mA
Circuit current	$I_{CC2(10)}$	No load	5.5	10	14	mA
Video amp gain	G_{ν}	Input a video signal (1V _{PP}) to Pin(9), measure the output of Pin(1)	5.1	6.5	7.9	dB
Video amp dynamic range	DR_{ν}	Input a video signal (1.3V _{PP}) to Pin ⁽¹⁾ , measure the output of Pin ⁽¹⁾	1.7	2.1	2.5	V
Synchronous separating capability (1)	HSep1	Input only SYNC to Pin and measure the minimum level at which synchronization is provided.	0.2			v
Synchronous separating capability (2)	HSep2	Input SYNC (0.29V _{PP}) plus video component to Pin [®] and measure the maximum video level at which synchronization is provided.	_	—	1.3	v
Video signal HD width	$ au_{ ext{HD}}$	Measure the time from the falling of input HD to blanking OFF of Pin① output.	7.5	8.5	9.5	μs
AFC output HD width	7 AFCHD	Input a signal to Pin (9) and measure while Pin (14) is Lo.	10.5	11.5	12.5	μs
Horizontal free-oscillation frequency	f _{HO}	Measure the output frequency of Pin 4 in the horizontal free-oscillation mode.	13.75	15.75	17.75	kHz
AFC lock range	f_{AFC}	Change the frequency of input signal to Pin and measure the synchronizing frequency.	15.25	15.75	16.25	kHz
AFC control sensitivity	β	Flow in and out current to Pin and measure the difference in frequency of Pin output.	720	840	960	Hz/μA
Vertical separating time	tvsep	Input a signal from Pin® and measure the difference in falling between Pin® output and input VD.	30	50	70	μs
Video signal VD width	TVOUT	Measure the time from the falling of input VD signal to blanking OFF of Pin① output.	1	1.2	1.4	ms
Vertical free-oscillation frequency	f _{VO}	Measure the oscillation frequency of Pin® in the vertical free-oscillation mode.	47	51	55	Hz
Vertical deflection output amplitude (1)	v _{VDEF(1)}	Input a signal (1V _{PP}) from Pin [®] and measure the output of Pin [®] .	1.3	1.6	1.9	V
Vertical deflection output amplitude (2)	v _{VDEF(2)}	Input a signal (1V _{PP}) from Pin [®] and measure the output of Pin [®] .	1.3	1.6	1.9	V
Vertical output dynamic range (1)	D _{RVDEF(1)}	Input a signal (1V _{PP}) from Pin [®] and measure the output of Pin [®] .	2	2.4	2.8	V
Vertical output dynamic range (2)	D _{RVDEF(2)}	Input a signal (1V _{PP}) from Pin [®] and measure the output of Pin [®] .	2	2.4	2.8	V
VD width	$ au_{ m VD}$	Input a signal to Pin and measure while Pin is Lo.	800	900	1000	μs

ICs for Video Camera

■ Application Circuit



■ Pin Descriptions

Pin No.	Pin name	Typ. waveform	Description	Equivalent circuit
1	Vertical size control input	IV	Control the V size of the vertical deflection coil driving pin.	
2	Power pin	DC 5V	Vertical deflection driving circuit $V_{\rm CC}$.	
3	Vertical deflection coil driving Pin①	1V	Vertical deflection coil driving output.	
4	GND	DC 0V	Vertical deflection driving circuit GND.	
5	Vertical deflection coil driving Pin②	IV	Vertical deflection coil driving output (inversion of Pin③).	
6	Vertical oscillating resistance pin	<u>D</u> C 0.7V	Vertical oscillating resistor pin.	

■ Pin Descriptions (cont.)

Pin No.	Pin name	Typ. waveform	Description	Equivalent circuit	
7	Vertical oscillating capacitor pin	IV IV	Determine the vertical free-oscillation frequency by the resistor of Pin® and capacitor of Pin⑦.		
8	V_D output pin	1V	Pulse output synchronized with a vertical oscillation waveform.		
9	Vertical synchronous separating capacitor pin	4V 0V	Charges and discharges the vertical synchronous separating capacitor.		
10	GND	DC 0V	Main circuit GND		
11	Video input	TH IH	Clamped to the video signal input pin (1.6V).		ICs for Video Camera
12	Power pin	DC 5V	Main circuit V _{CC} .		
13	Video amp output pin	~~~~~	Amplified to the video amp signal output (6.5dB).		
14	Phase comparator output	DC	The output DC of the phase comparator changes and AFC operates.	***************************************	
15	Horizontal oscillating resistor pin	DC 2V	Horizontal free-oscillation frequency determining resistor.		٠
16	Horizontal AFC output	5v	A pulse waveform synchronized with a horizontal oscillation waveform is output.		

■ Supplementary Explanation

· Precautions on Use

1. Horizontal free oscillation frequency adjusting method

The frequency of Pin should essentially be adjusted to 15.75Hz by the counter, changing the resistor of Pin at no signal input. But this causes the voltage of Pin (AFC detecting pin) to be about 2V when a signal is input. Because supply voltage is 5V (typ.), it is desirable to use a digital voltmeter so that the voltage of Pin may be 2.5V, considering dispersion, etc.

2. External constant of Pin 15

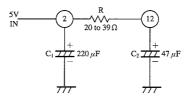
The following value is recommeded to take in the dispersion of horizontal free oscillation frequency of IC.

3. Vertical oscillating R.C

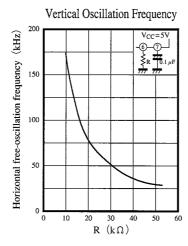
High-precision parts should be used for the grounding resistor of Pin® and grounding capacitor of Pin® which determine vertical free-oscillation frequency. Because of 54Hz (typ.) at C_7 =0.1 μ F and R_6 =30k Ω , the value of R_6 is desirable to be 33 to 36k Ω , considering the dispersion and temperature characteristics of IC in ordernot to be out of vertical synchronization.

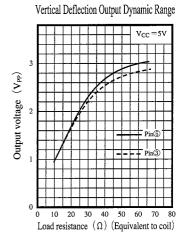
4. Power filter

It is recommended to use the following filter for power pins of Pins② and ③, to prevent from being out of vertical synchronization and horizontal noise. C_2 of good temperature characteristics should be used.



Characteristic Curve





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